## Surface Mount

# Monolithic Amplifier DC-4 GHz

#### **Product Features**

- DC-4 GHz
- Single Voltage Supply
- Internally matched to 50 Ohms
- Unconditionally Stable
- Low Performance Variation Over Temperature
- Transient protected
- Aqueous washable
- Protected by US Patent 6,943,629

## **Typical Applications**

- Cellular/ PCS/ 3G Base Station
- CATV, Cable Modem & DBS
- Fixed Wireless & WLAN
- Microwave Radio & Test Equipment



## ERA-5SM+

CASE STYLE: WW107 PRICE: \$3.90 ea. QTY. (30)

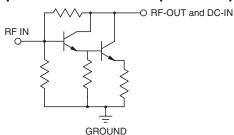
+ RoHS compliant in accordance with EU Directive (2002/95/EC)

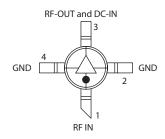
The +Suffix has been added in order to identify RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications.

## **General Description**

ERA-5SM+ (RoHS compliant) is a wideband amplifier offering high dynamic range. It has repeatable performance from lot to lot. It is enclosed in an Micro-X package. ERA-5SM+ uses Darlington configuration and is fabricated using InGaP HBT technology. Expected MTBF is 850 years at 85°C case temperature.

## simplified schematic and pin description





Function	Pin Number	Description
RF IN	1	RF input pin. This pin requires the use of an external DC blocking capacitor chosen for the frequency of operation.
RF-OUT and DC-IN 3		RF output and bias pin. DC voltage is present on this pin; therefore a DC blocking capacitor is necessary for proper operation. An RF choke is needed to feed DC bias without loss of RF signal due to the bias connection, as shown in "Recommended Application Circuit".
GND	2,4	Connections to ground. Use via holes as shown in "Suggested Layout for PCB Design" to reduce ground path inductance for best performance.

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## Electrical Specifications at 25°C and 65mA, unless noted

Parameter		Min.	Тур.	Max.	Units	Cpk
Frequency Range*		DC		4	GHz	
Gain	f=0.1GHz f=1 GHz f=2 GHz f=3 GHz f=4 GHz	19 16 12	20.2 19.5 17.6 15.6 14	22 19 16	dB	≥1.5
Magnitude of Gain Variation versus Temperature (values are negative)	f=0.1GHz f=1 GHz f=2 GHz f=3 GHz f=4 GHz		.0025 .0034 .0043 .0052 .0065	.005 .007 .0085 .0105 .013	dB/°C	
Input Return Loss	f=0.1 GHz f=2 GHz f=4 GHz		21 23 21		dB	
Output Return Loss	f=0.1 GHz f=2 GHz f=4 GHz		30 26 17		dB	
Reverse Isolation	f=2 GHz	19	22		dB	
Output Power @1 dB compression	f=0.1 GHz f=1 GHz f=2 GHz f=4 GHz	16.5 16.5 15.5	18.4 18.4 17 12.5		dBm	≥1.5
Saturated Output Power (at 3dB compression)	f=0.1 GHz f=1 GHz f=2 GHz		19.5 18.5 18		dBm	
Output IP3	f=0.1 GHz f=1 GHz f=2 GHz f=4 GHz	30 30 26	33 33 30 26		dBm	<u>&gt;</u> 1.5
Noise Figure	f=0.1GHz f=2 GHz f=4 GHz		3.5 3.5 3.5	4.5 4.5 4.5	dB	≥1.5
Group Delay	f=2 GHz		90		psec	
Recommended Device Operating Current			65		mA	<u> </u>
Device Operating Voltage		4.5	4.9	5.3	V	≥1.5
Device Voltage Variation vs. Temperature at 65mA			-3.2		mV/°C	
Device Voltage Variation vs. Current at 25°C			6.9		mV/mA	
Thermal Resistance, junction-to-case <sup>1</sup>			133		°C/W	

<sup>\*</sup>Guaranteed specification DC-4 GHz. Low frequency cut off determined by external coupling capacitors.

#### **Absolute Maximum Ratings**

Parameter	Ratings	
Operating Temperature*	-45°C to 85°C	
Storage Temperature	-65°C to 150°C	
Operating Current	85mA	
Power Dissipation	451mW	
Input Power	13 dBm	

Note: Permanent damage may occur if any of these limits are exceeded.

<sup>\*</sup>Based on typical case temperature rise 10°C above ambient.

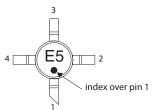


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These ratings are not intended for continuous normal operation.

<sup>&</sup>lt;sup>1</sup>Case is defined as ground leads.

## **Product Marking**



Markings in addition to model number designation may appear for internal quality control purposes.

#### **Additional Detailed Technical Information**

Additional information is available on our web site. To access this information enter the model number on our web site home page.

Performance data, graphs, s-parameter data set (.zip file)

Case Style: WW107

Plastic micro-x, .085 body diameter, lead finish: tin/silver/nickel

Tape & Reel: F4

Suggested Layout for PCB Design: PL-075

**Evaluation Board: TB-408-5+** 

**Environmental Ratings: ENV08T2** 

## **Recommended Application Circuit**

Test Board includes case, connectors, and components (in bold) soldered to PCB

R BIAS				
Vcc	"1%" Res. Values (ohms) for Optimum Biasing			
7	33.2			
8	48.7			
9	63.4			
10	78.7			
11	95.3			
12	110			
13	124			
14	140			
15	158			
16	174			
17	187			
18	205			
19	221			
20	232			

### **ESD Rating**

Human Body Model (HBM): Class 1B (500 v to < 1,000 v) in accordance with ANSI/ESD STM 5.1 - 2001

Machine Model (MM): Class M1 (< 100 v) in accordance with ANSI/ESD STM 5.2 - 1999

## **MSL Rating**

Moisture Sensitivity: MSL1 in accordance with IPC/JEDECJ-STD-020C

NO.	TEST REQUIRED	CONDITION	STANDARD	QUANTITY
1	Visual Inspection	Low Power Microscope Magnification 40x	MIP-IN-0003 (MCT spec)	45 units
2	Electrical Test	Room Temperature	SCD (MCL spec)	45 units
3	SAM Analysis	Less than 10% growth in term of delamination	J-Std-020C (Jedec Standard)	45 units
4	Moisture Sensitivity Level 1	Bake at 125°C for 24 hours Soak at 85°C/85%RH for 168 hours Reflow 3 cycles at 260°C peak	J-Std-020C (Jedec Standard)	45 units

#### **MSL Test Flow Chart**

